

**J108, J109****N-Channel Silicon Junction Field-Effect Transistor**

- Choppers
- Commutators
- Analog Switches

**Absolute maximum ratings at  $T_A = 25^\circ\text{C}$** 

Reverse Gate Source & Reverse Gate Drain Voltage	- 25 V
Continuous Forward Gate Current	50 mA
Continuous Device Power Dissipation	360 mW
Power Derating	3.27 mW/ $^\circ\text{C}$

At 25°C free air temperature:

		J108		J109		Process NJ450	
		Min	Max	Min	Max	Unit	Test Conditions
Gate Source Breakdown Voltage	$V_{(\text{BR})\text{GSS}}$	- 25		- 25		V	$I_G = - 1 \mu\text{A}, V_{DS} = 0\text{V}$
Gate Reverse Current	$I_{GSS}$		- 3		- 3	nA	$V_{GS} = - 15\text{V}, V_{DS} = 0\text{V}$
Gate Source Cutoff Voltage	$V_{GS(\text{OFF})}$	- 3	- 10	- 2	- 6	V	$V_{DS} = 5\text{V}, I_D = 1 \mu\text{A}$
Drain Saturation Current (Pulsed)	$I_{DSS}$	80		40		mA	$V_{DS} = 15\text{V}, V_{GS} = 0\text{V}$
Drain Cutoff Current	$I_{D(\text{OFF})}$		3		3	nA	$V_{DS} = 5\text{V}, V_{GS} = - 10\text{V}$

**Dynamic Electrical Characteristics**

Drain Source ON Resistance	$r_{ds(\text{on})}$		8		12	$\Omega$	$V_{GS} = \emptyset, V_{DS} \leq 0.1\text{V}$	$f = 1 \text{ kHz}$
Drain Gate Capacitance	$C_{gd}$		15		15	pF	$V_{DS} = 0\text{V}, V_{GS} = - 10\text{V}$	$f = 1 \text{ MHz}$
Source Gate Capacitance	$C_{gs}$		15		15	pF	$V_{DS} = 0\text{V}, V_{GS} = - 10\text{V}$	$f = 1 \text{ MHz}$
Drain Gate + Source Gate Capacitance	$C_{gd} + C_{gs}$		85		85	pF	$V_{DS} = V_{GS} = 0\text{V}$	$f = 1 \text{ MHz}$

**Switching Characteristics**

		Typ	Typ		J108	J109
Turn ON Delay Time	$t_{d(\text{on})}$	3	3	ns		
Rise Time	$t_r$	1	1	ns	$V_{DD}$	1.5
Turn OFF Delay Time	$t_{d(\text{off})}$	4	4	ns	$V_{GS(\text{OFF})}$	- 12
Fall Time	$t_f$	18	18	ns	$R_L$	150

**TO-226AA Package**

Dimensions in Inches (mm)

**Pin Configuration**

1 Drain, 2 Source, 3 Gate

**Surface Mount**

SMPJ108, SMPJ109

